

Applications

- Commercial and military radar
- Communications
- Electronic Warfare

Product Features

- Frequency Range: 0.1 – 3.0GHz
- P_{SAT} : >40dBm at $PIN = 27dBm$
- $P1dB$: >35dBm
- PAE: 50% @ midband
- Large Signal Gain: >13dB
- Small Signal Gain: 21dB
- Bias: $V_D = 40V$, $I_{DQ} = 360mA$, $V_{G1} = -2.4V$ Typical, $V_{G2} = +17.7V$ Typical
- Wideband Flat Gain and Power
- Package Dimensions: 5.0 x 5.0 x 1.45 mm

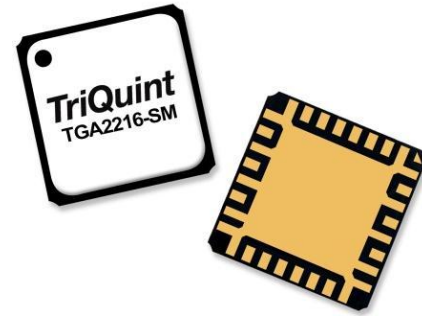
General Description

TriQuint's TGA2216-SM is a wideband cascode amplifier fabricated on TriQuint's production 0.25um GaN on SiC process. The cascode configuration offers exceptional wideband performance as well as supporting 40V operation. The TGA2216-SM operates from 0.1 - 3.0GHz and provides greater than 10W of saturated output power with greater than 13dB of large signal gain and greater than 40% power-added efficiency.

The TGA2216-SM is available in a low-cost, surface mount 32 lead 5x5 AIN QFN. It is ideally suited to support both radar and communication applications across defense and commercial markets as well as electronic warfare. The TGA2216-SM is fully matched to 50Ω at both RF ports allowing for simple system integration. DC blocks are required on both RF ports and the drain voltage must be injected through an off chip bias-tee on the RF output port.

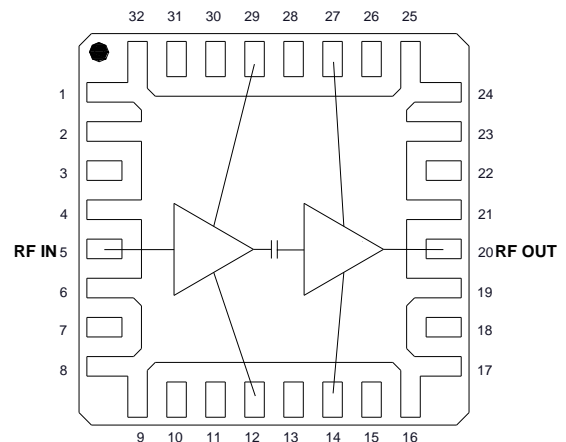
Lead-free and RoHS compliant.

Evaluation boards are available upon request.



QFN 5x5 mm 32L

Functional Block Diagram



Pad Configuration

Pad No.	Symbol
1-2, 4, 6, 8-9, 16-17, 19, 21, 23-25, 32	GND
3, 7, 10-11, 13, 15, 18, 22, 26, 28, 30-31	NC
5	RF IN
12, 29	GATE 1
14, 27	GATE 2
20	RF OUT, DRAIN

Ordering Information

Part	ECCN	Description
TGA2216-SM	EAR99	0.1 – 3.0GHz 10W GaN Power Amplifier

Absolute Maximum Ratings

Parameter	Value
Drain Voltage (V_D)	80V
Gate Voltage Range (V_{G1})	-8 to 0V
Gate Voltage Range (V_{G2})	0 to 40V
Drain Current (I_D)	760mA
Gate Current (I_{G1})	-5 to 5.6mA
Gate Current (I_{G2})	-5 to 5.6mA
Power Dissipation (P_{DISS}), 85°C	28W
Input Power (P_{IN}), CW, 50 Ω , 85°C,	33dBm
Input Power (P_{IN}), CW, VSWR 10:1, $V_D = 40V$, 85°C	27dBm
Channel Temperature (T_{CH})	275°C
Mounting Temperature (30 Seconds)	320°C
Storage Temperature	-55 to 150°C

Operation of this device outside the parameter ranges given above may cause permanent damage. These are stress ratings only, and functional operation of the device at these conditions is not implied.

Recommended Operating Conditions

Parameter	Value
Drain Voltage (V_D)	40V
Drain Current (I_{DQ})	360mA
Gate Voltage (V_{G1})	-2.4V (Typ.)
Gate Voltage (V_{G2})	+17.7V (Typ.)

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions.

Electrical Specifications

Test conditions unless otherwise noted: 25°C, $V_D = 40V$, $I_{DQ} = 360mA$, $V_{G1} = -2.4V$ Typical, $V_{G2} = +17.7V$ Typical

Parameter	Min	Typical	Max	Units
Operational Frequency Range	0.1		3.0	GHz
Small Signal Gain		21		dB
Input Return Loss		> 8		dB
Output Return Loss		> 11		dB
Output Power ($P_{in} = 27dBm$)		> 40		dBm
Power Added Efficiency ($P_{in} = 27dBm$)		50 (mid band)		%
Power @ 1dB Compression (P_{1dB})		> 35		dBm
IM3 @ 120mA, $P_{OUT}/tone = 30dBm$		-25		dBc
IM5 @ 120mA, $P_{OUT}/tone = 30dBm$		-33		dBc
Small Signal Gain Temperature Coefficient		-0.03		dB/°C
Output Power Temperature Coefficient		-0.007		dBm/°C
Recommended Operating Voltage:		40	48	V

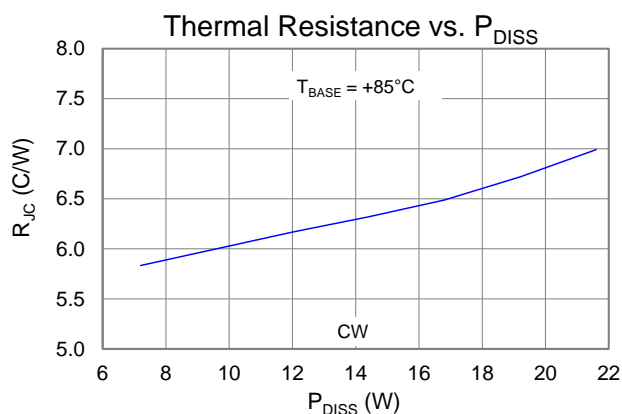
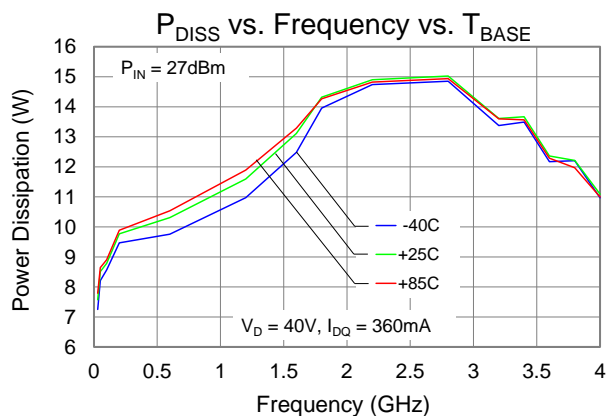
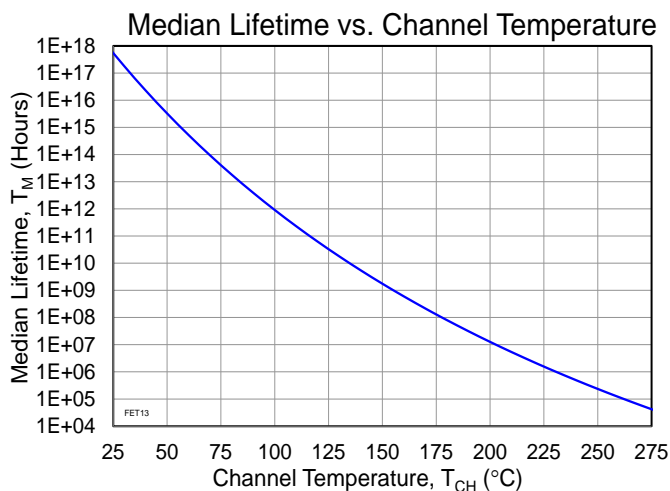
Thermal and Reliability Information

Parameter	Test Conditions	Value	Units
Thermal Resistance (θ_{JC}) ⁽¹⁾	$T_{base} = 85^{\circ}\text{C}$, $V_D^{(2)} = 40\text{V (CW)}$	6.32	$^{\circ}\text{C/W}$
Channel Temperature (T_{CH}) (Under RF drive)	$I_{DQ} = 360\text{mA}$, $I_{D_Drive} = 610\text{mA}$	179	$^{\circ}\text{C}$
Median Lifetime (T_M)	$P_{IN} = 27\text{dBm}$, $P_{OUT} = 40\text{dBm}$, $P_{DISS} = 15\text{W}$	7.99×10^7	Hrs

Notes:

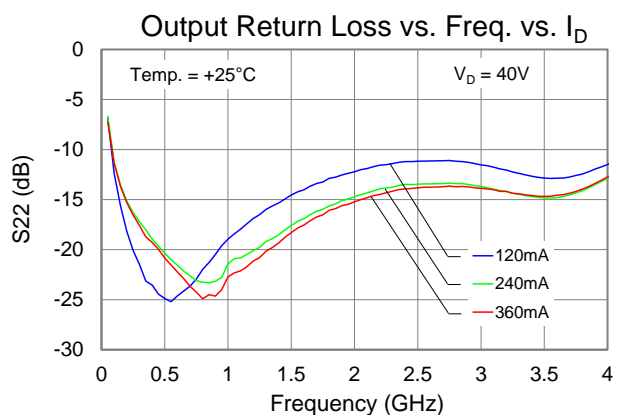
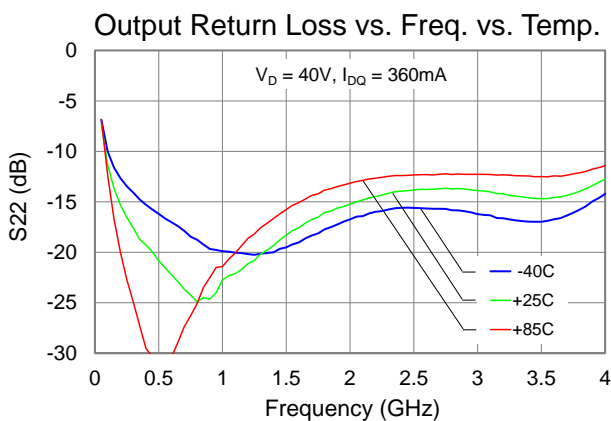
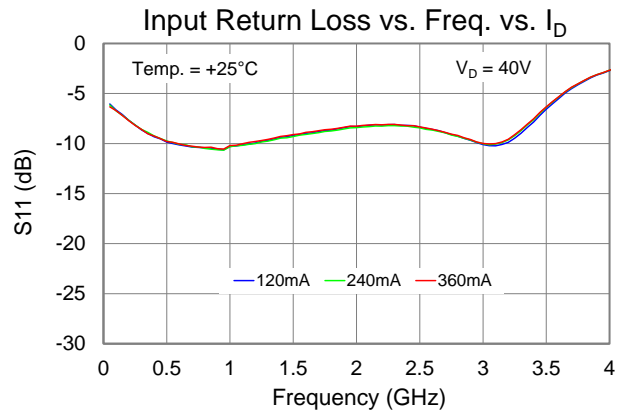
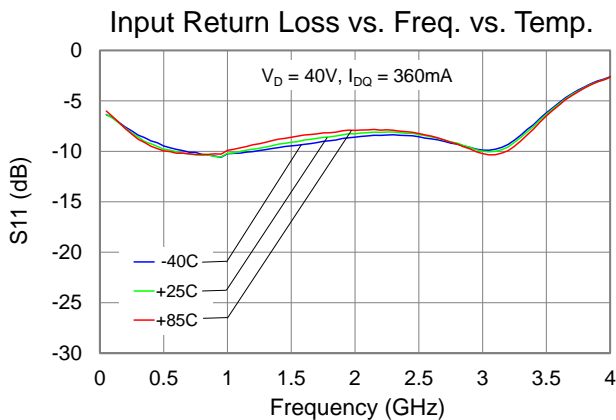
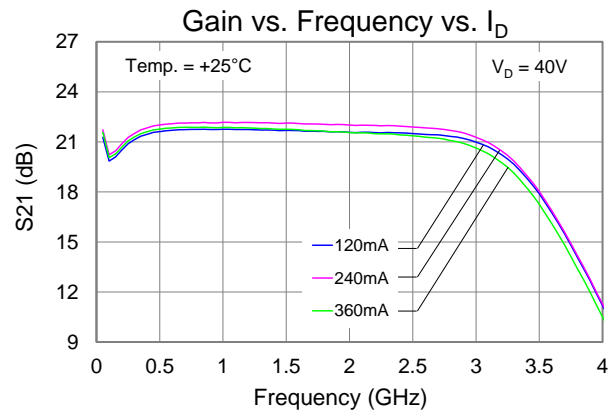
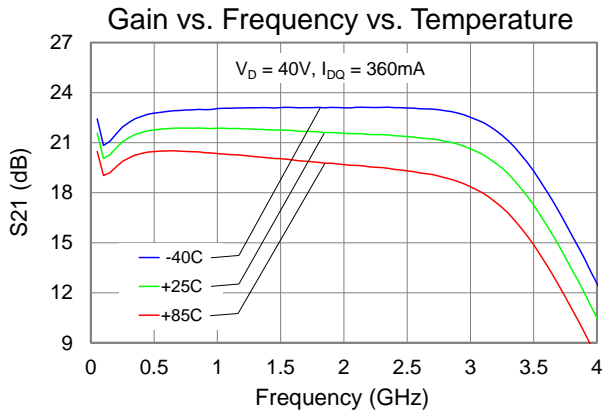
1. Thermal resistance measured to back of package.
2. The drain voltage for Cascode amplifier transistor is $\frac{1}{2}$ of the V_D .

Test Conditions: $V_D = 40\text{V}$; Failure Criteria = 10% reduction in I_{D_MAX}



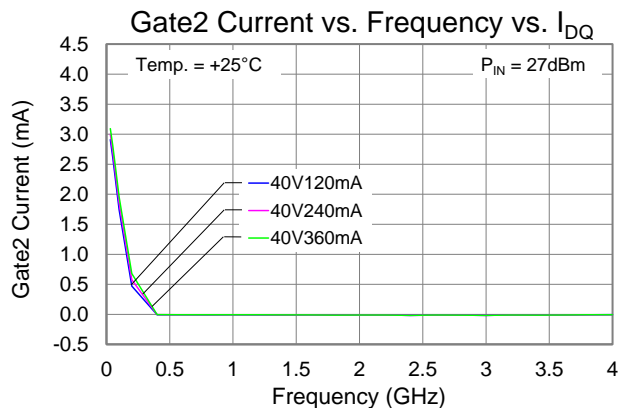
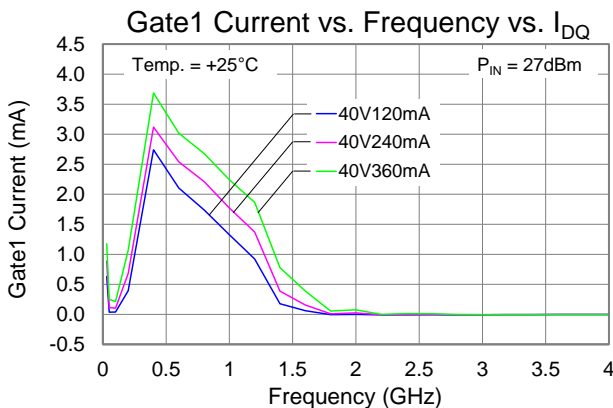
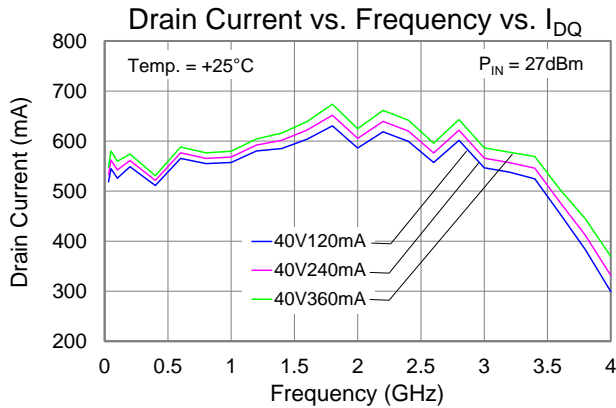
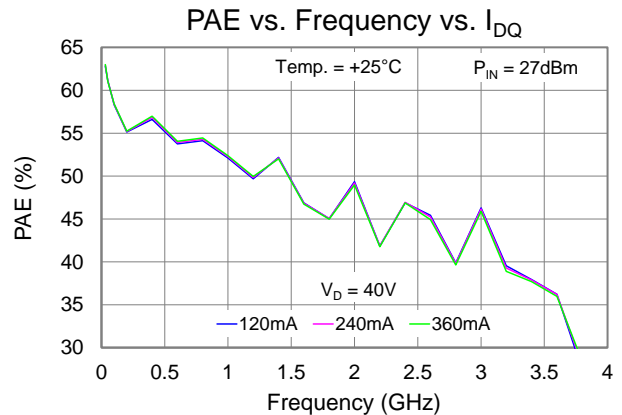
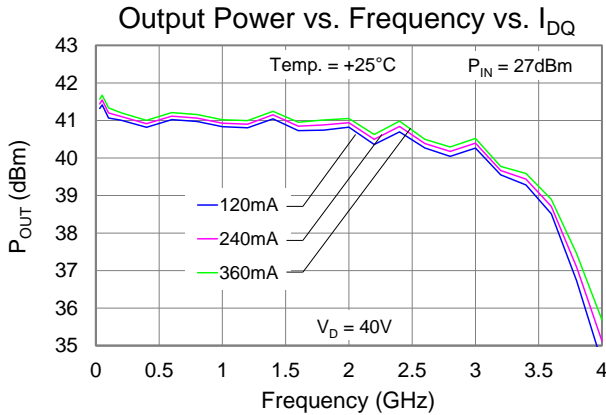
Typical Performance: Small Signal

The plots reflect performance measured with an external coaxial bias tee and DC blocks
(See application circuit on page 11)



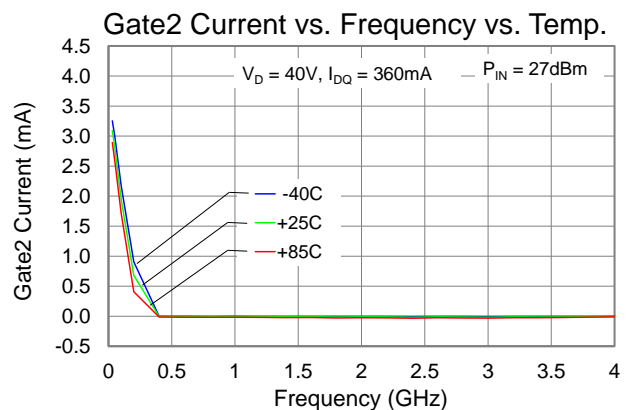
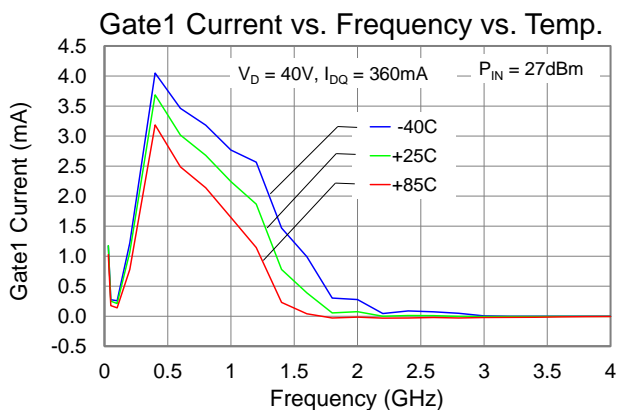
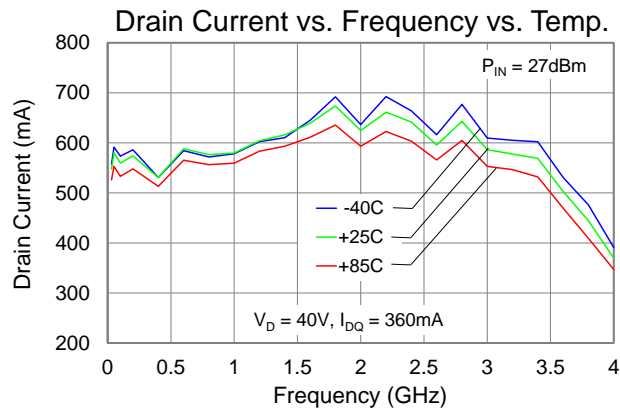
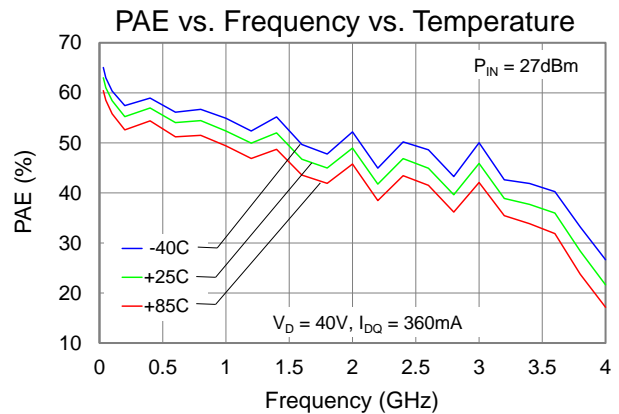
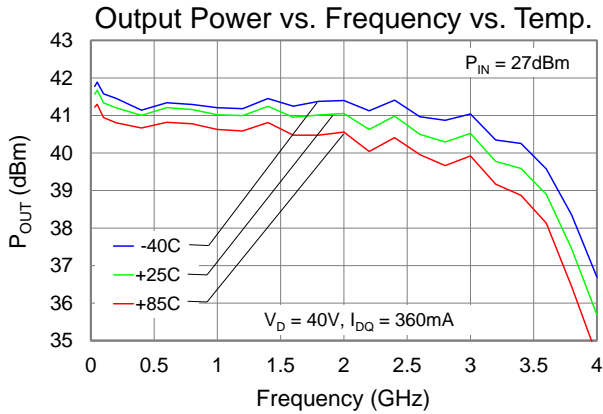
Typical Performance: Large Signal (CW)

The plots reflect performance measured with an external coaxial bias tee and DC blocks
 (See application circuit on page 11)



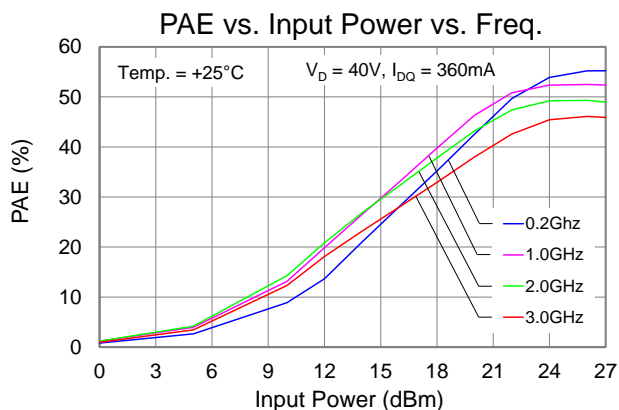
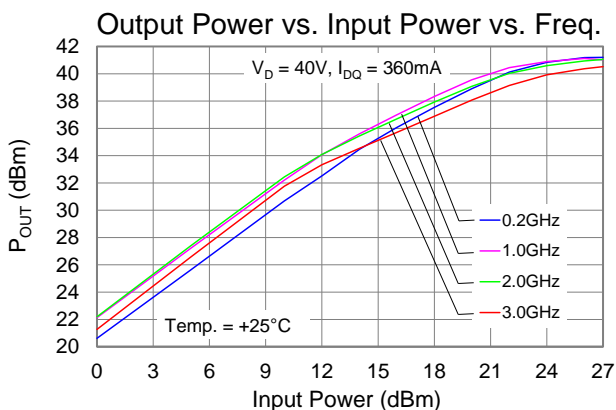
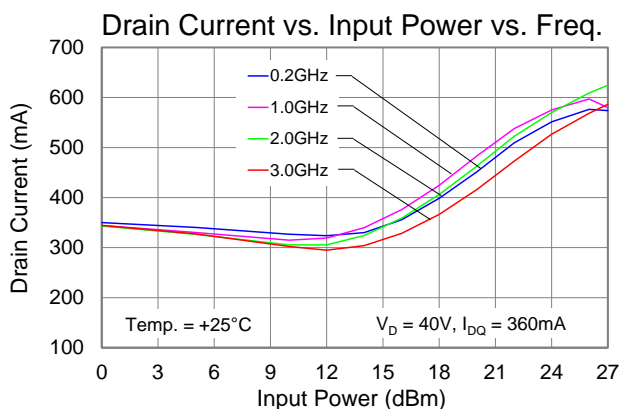
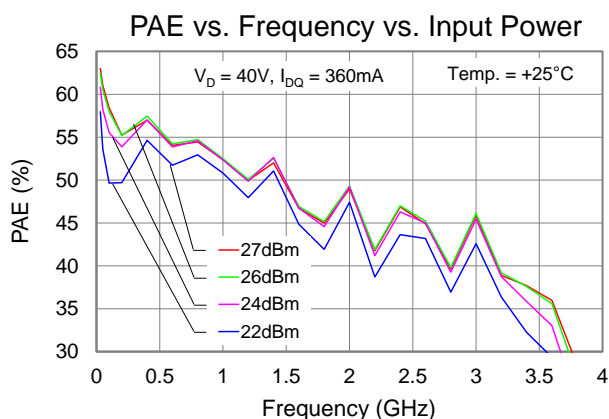
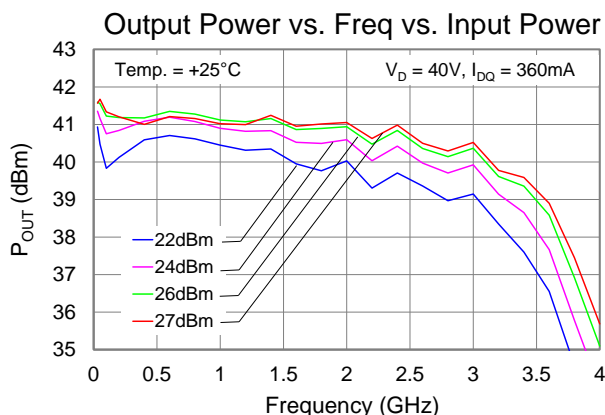
Typical Performance: Large Signal (CW)

The plots reflect performance measured with an external coaxial bias tee and DC blocks
(See application circuit on page 11)



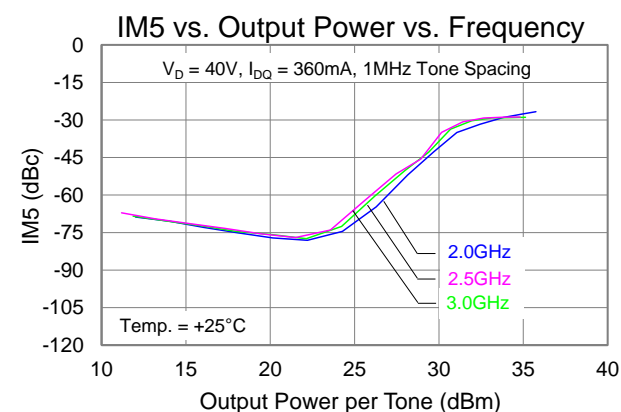
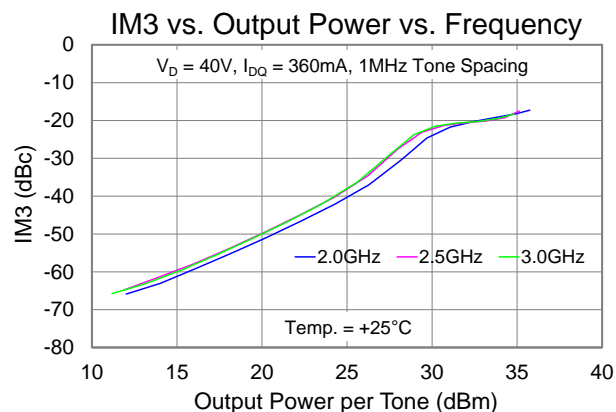
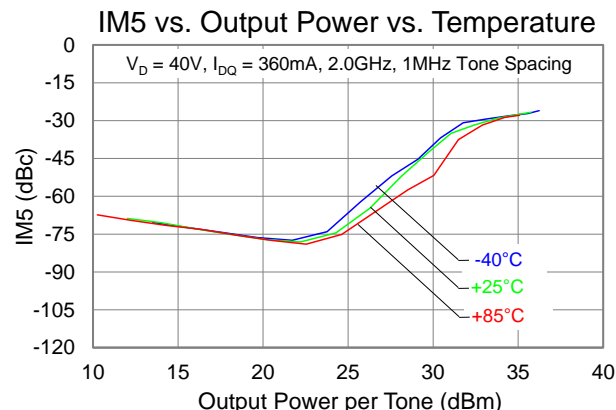
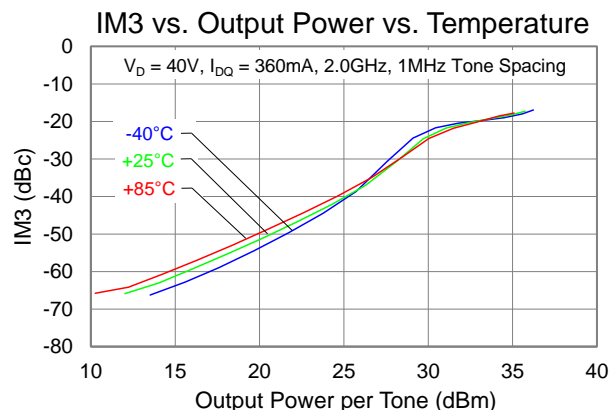
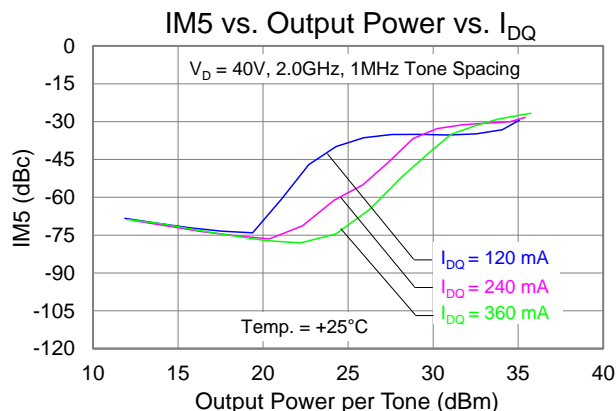
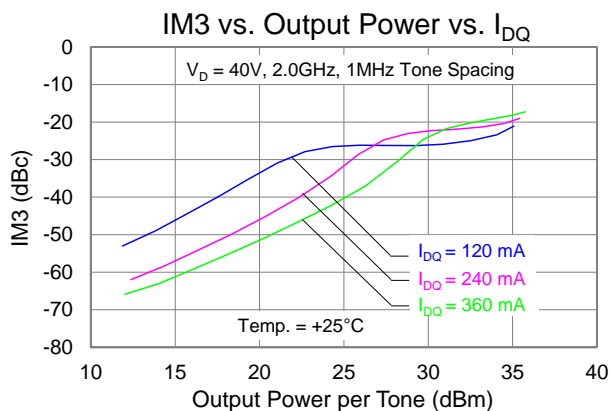
Typical Performance: Large Signal (CW)

The plots reflect performance measured with an external coaxial bias tee and DC blocks
(See application circuit on page 11)



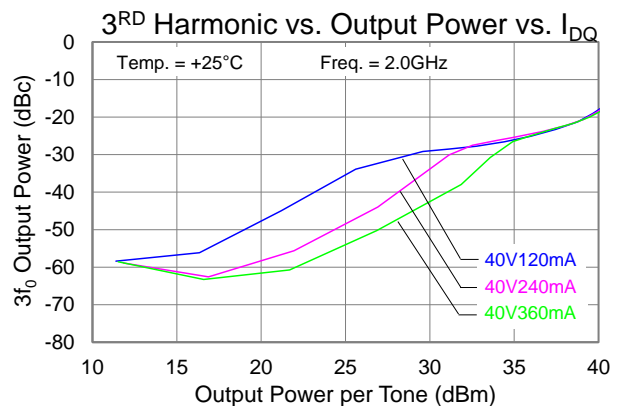
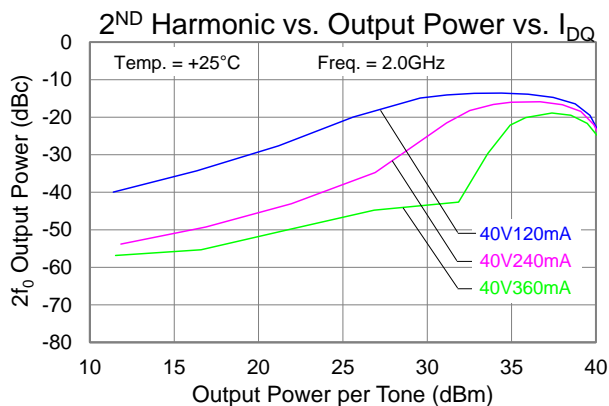
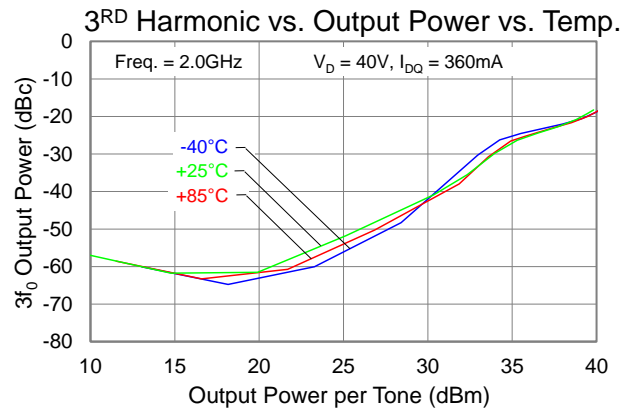
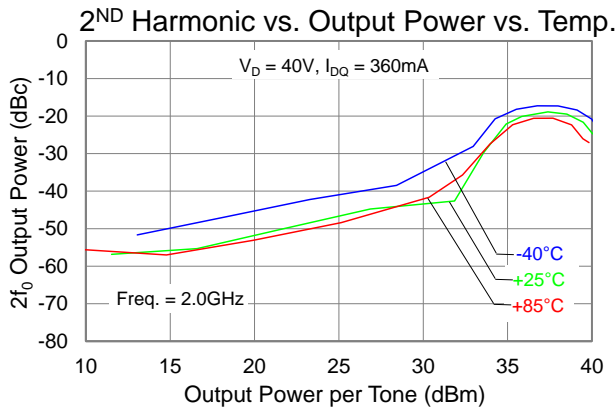
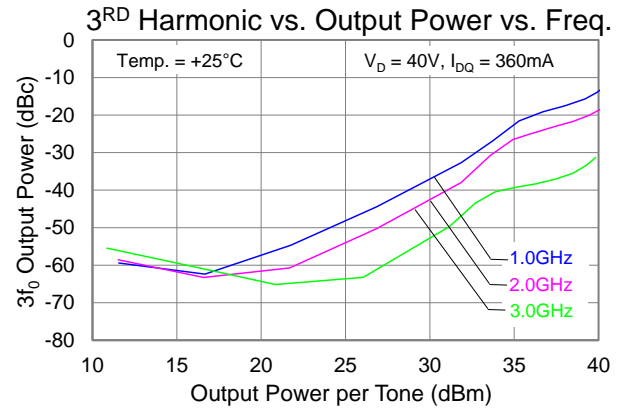
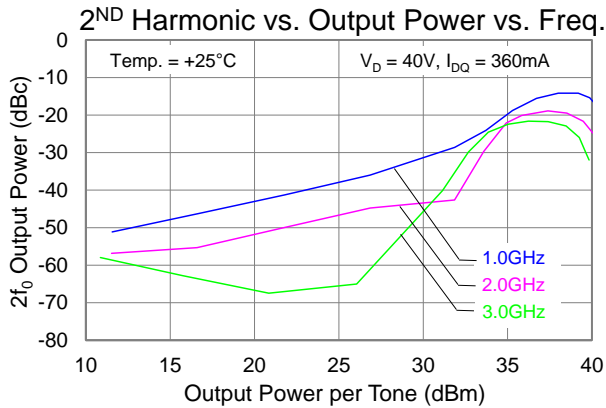
Typical Performance: Linearity

The plots reflect performance measured with an external coaxial bias tee and DC blocks
(See application circuit on page 11)



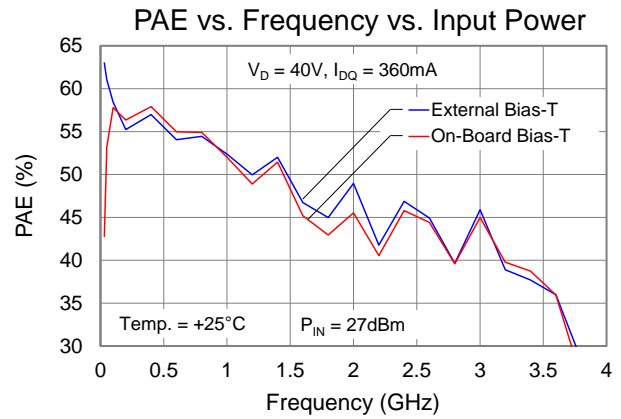
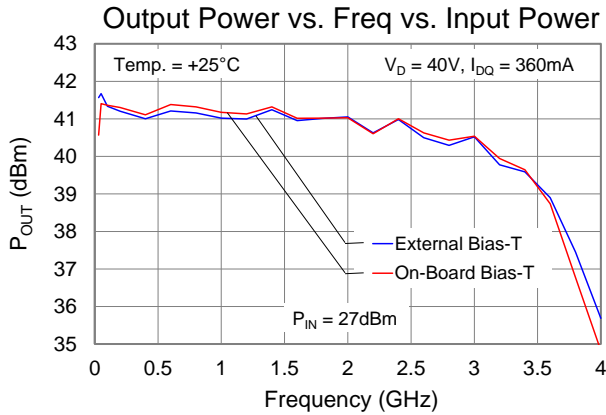
Typical Performance: Linearity

The plots reflect performance measured with an external coaxial bias tee and DC blocks
(See application circuit on page 11)

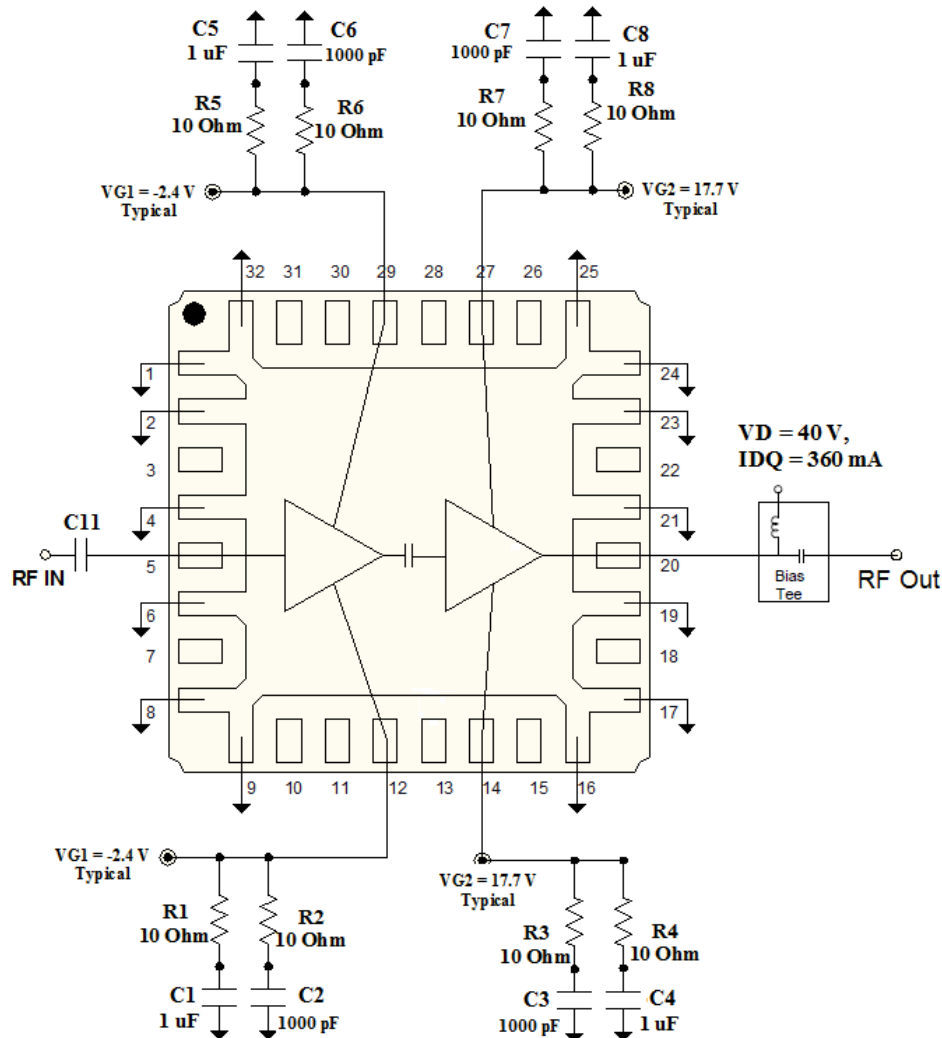


Typical Performance: Large Signal (CW), On-board vs. External Coaxial Bias-T

The plots below reflect performance measured between external bias tee and on-board bias tee
(See application circuit on pages 11 and 13)



Application Circuit (Coaxial input DC block and coaxial output bias tee)



Notes:

1. V_{G1} & V_{G2} can be biased from either side (Top or Bottom.)
2. Coaxial input DC block (C11) is used for input port (RF In.)
3. External wide bandwidth Bias-Tee is used for output port (RF Out). V_D is applied through the output Bias-Tee.

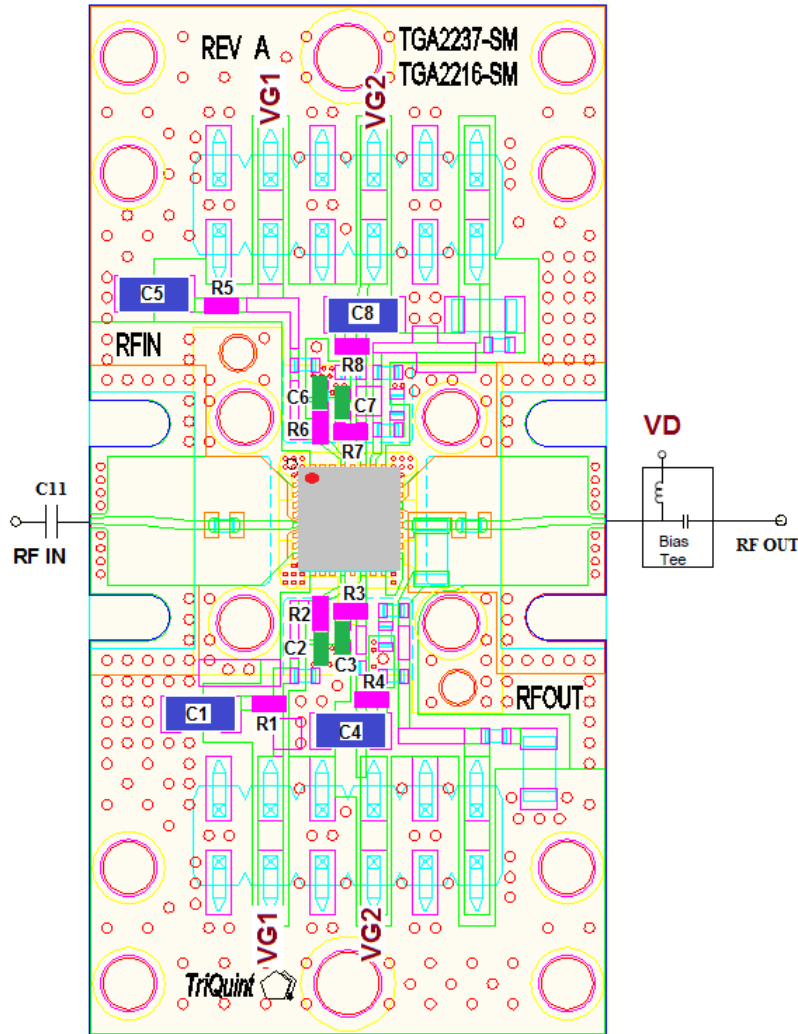
Bias-up Procedure

1. Set I_D limit to 720mA, I_{G1} & I_{G2} limit to 5mA
2. Set V_{G1} to -5.0V
3. Set V_{G2} to $(V_D/2) - 2.7V$ or $40V/2 - 2.7V = 17.3V$
4. Set V_D +40V
5. Adjust V_{G1} more positive until $I_{DQ} = 360mA$ ($V_{G1} \sim -2.4V$ Typical)
6. Adjust V_{G2} to $(V_D/2) + V_{G1}$; ($V_{G2} \sim +17.7V$ Typical)
7. Apply RF signal

Bias-down Procedure

1. Turn off RF signal
2. Reduce V_{G1} to -5.0V. Ensure $I_{DQ} \sim 0mA$
3. Reduce V_{G2} to 0V.
4. Set V_D to 0V
5. Turn off V_D supply
6. Turn off V_{G2} supply
7. Turn off V_{G1} supply

Assembly Drawing (Coaxial input DC block and coaxial output bias tee)

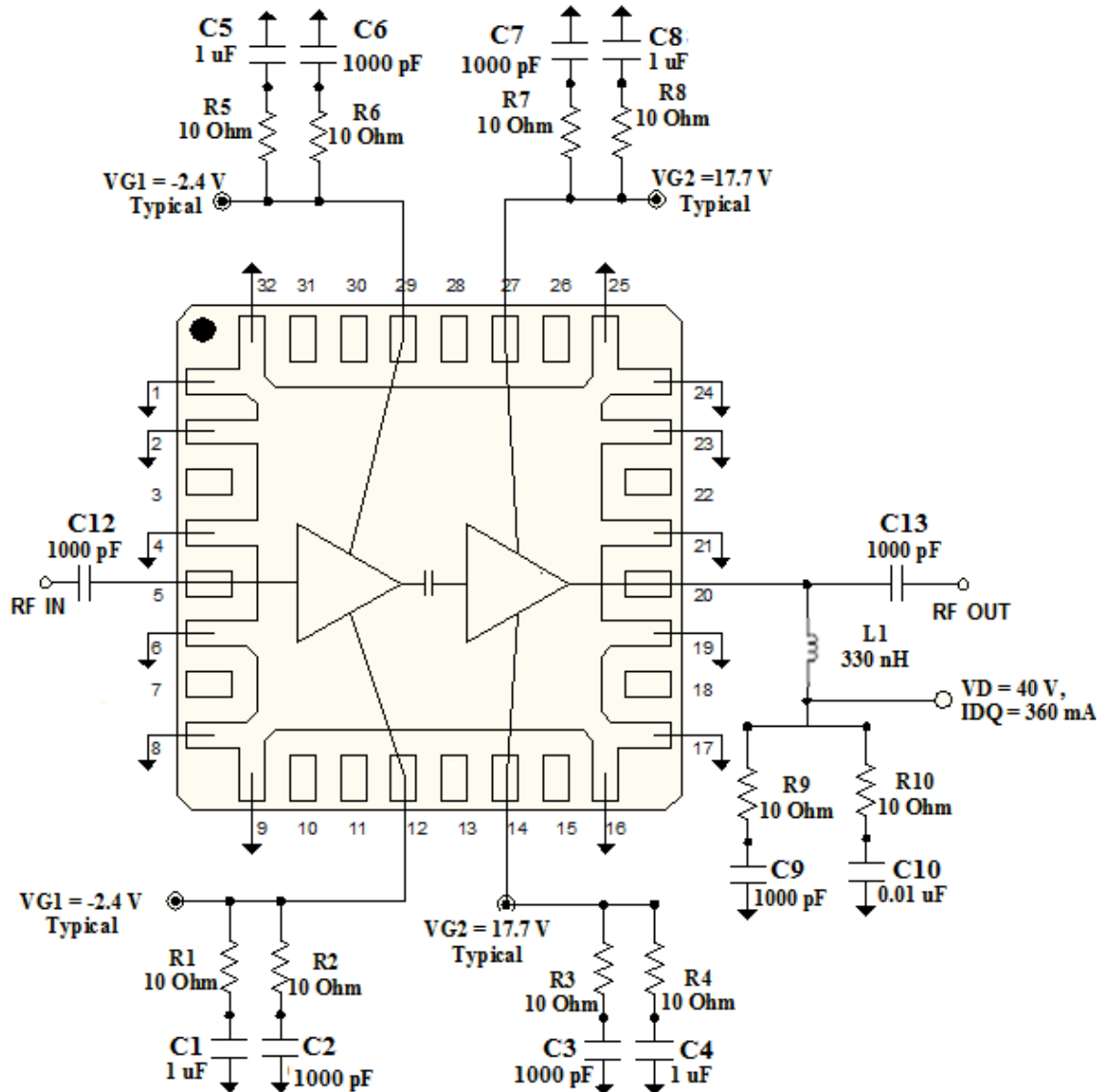


Bill of Materials

Reference Design	Value	Description	Manufacturer	Part Number
C1, C4, C5, C8	1uF	Cap, 1206, 50V, 10%, X7R	Various	
C2, C3, C6, C7	1000pF	Cap, 0402, 100V, 10%, X7R	Various	
C11		DC Block	Various	
R1 – R8	10Ω	Res, 0402	Various	

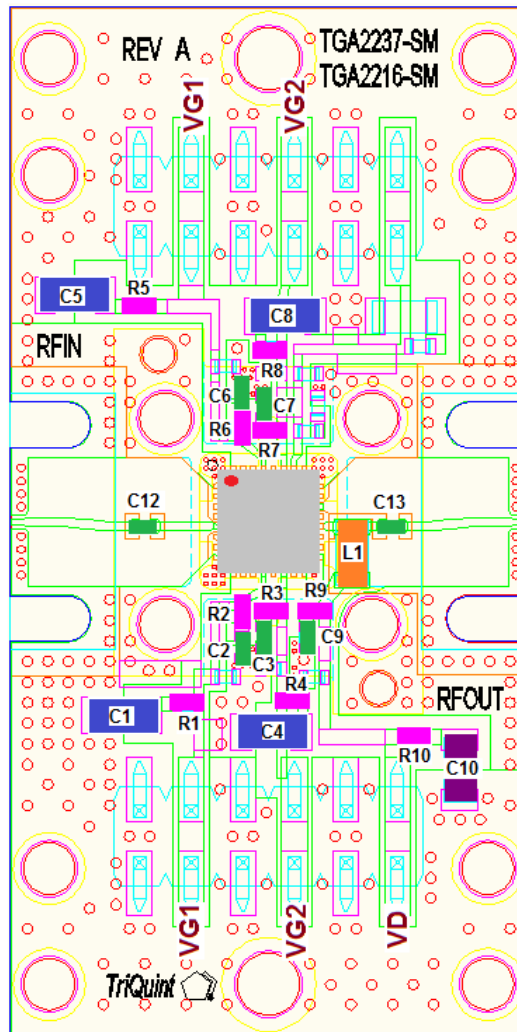
Notes:

Application Circuit (Option with board-level DC blocks and output bias tee)



1. Performance of the DUT with surface mount DC blocks and bias tee components may be degraded relative to the coaxial option. These components should be optimized for the desired operational bandwidth.
2. V_{G1} & V_{G2} can be biased from either side (Top or Bottom.)

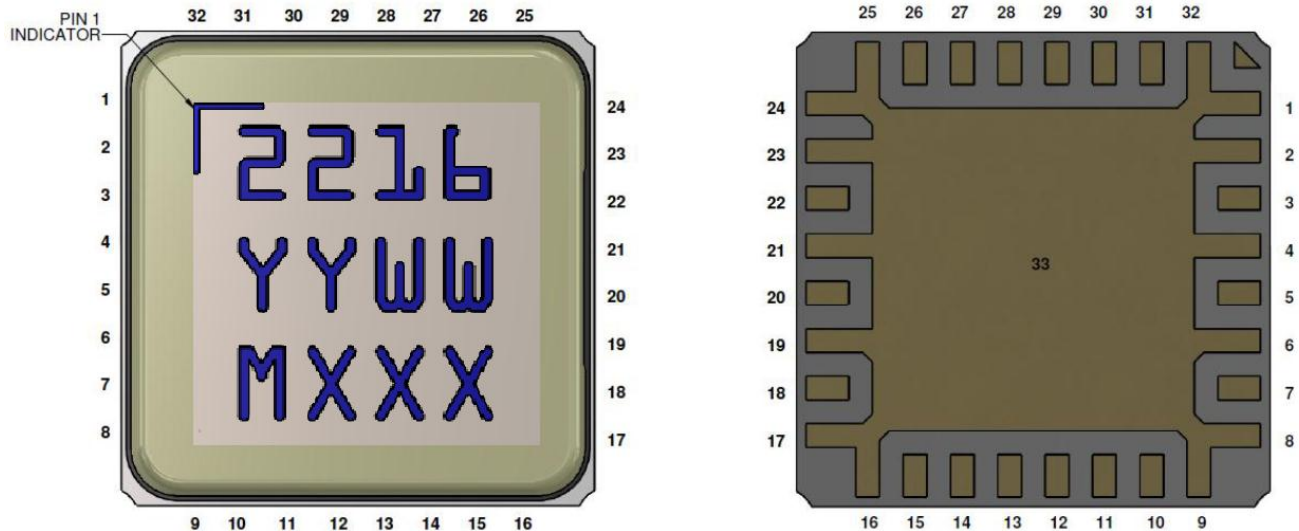
Evaluation Board Layout with On-Board DC Blocks and Output Bias-T Option



Bill of Materials For On-Board Bias-Tee

Reference Design	Value	Description	Manufacturer	Part Number
C1, C4, C5, C8	1uF	Cap, 1206, 50V, 10%, X7R		
C2-C3, C6-C7, C9, C12, C13	1000pF	Cap, 0402, 100V, 10%, X7R	Various	
C10	0.01uF	Cap, 1206, 100V, 10%, X7R	Various	
L1	330nH	Ind, 1206, 100V, 10%, X7R	Various	
R1 – R10	10Ω	Res, 0402	Various	

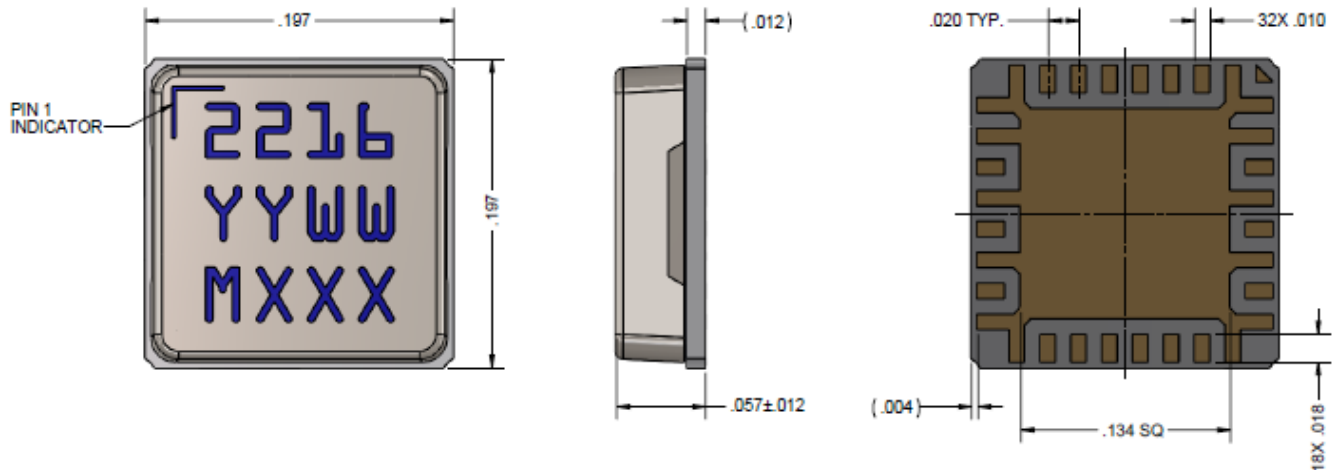
Pin Layout



Pin Description

Pin No.	Symbol	Description
1-2, 4, 6, 8-9, 16-17, 19, 21, 23-25, 32	GND	Connected to ground paddle (pin 33); must be grounded on PCB.
3, 7, 10-11, 13, 15, 18, 22, 26, 28, 30-31	NC	No connection.
5	RF IN	Input; matched to 50 Ω .
12, 29	GATE1	GATE voltage1; bias network is required; see recommended Application Information on page 11.
14, 27	GATE2	Gate voltage2; bias network is required; see recommended Application Information on page 11.
20	RF OUT/ DRAIN	Output; matched to 50 Ω .
33	GND	Ground Paddle. Multiple vias should be employed to minimize inductance and thermal resistance.

Mechanical Information



Units: inches

Tolerances: unless specified

x.xx = ± 0.01

x.xxx = ± 0.005

Materials:

Base: Ceramic

Lid: Plastic

All metalized features are gold plated

Part is epoxy sealed

Marking:

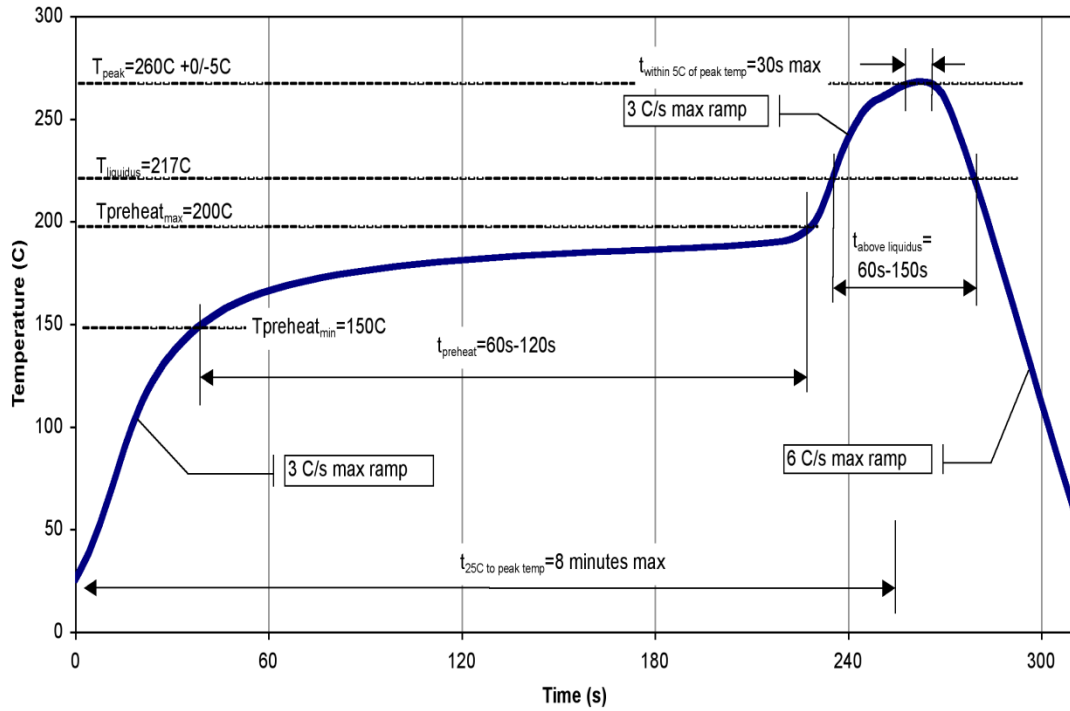
2216: Part number

YY: Part Assembly year

WW: Part Assembly week

MXXX: Batch ID

Recommended Soldering Temperature Profile



Product Compliance Information**ESD Sensitivity Ratings**

Caution! ESD-Sensitive Device

ESD Rating: TBD
Value: TBD
Test: Human Body Model (HBM)
Standard: JEDEC Standard JESD22-A114

ECCN

US Department of Commerce: EAR99

Solderability

This part is compliant with EU 2002/95/EC RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment).

This product also has the following attributes:

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A (C₁₅H₁₂Br₄O₂) Free
- PFOS Free
- SVHC Free

Contact Information

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For technical questions and application information: Email: info-products@triquint.com

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